General Description

The WSF10N40 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

Product Summery

BVDSS	RDSON	ID
400V	515mΩ	10A

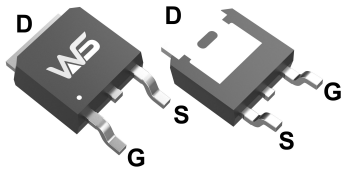
Applications

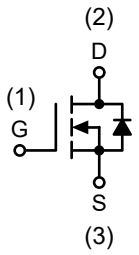
- DC-DC & DC-AC Converters for telecom,
- industrial and consumer environment
- Uninterruptible Power Supply (UPS)
- Switch Mode Low Power Supplies
- Industrial Actuators

Features

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

TO-252-2L Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	400	V
V_{GS}	Gate-Source Voltage	±25	V
I_D@T_C=25℃	Continuous Drain Current, V_{GS} @ 10V[1]	10.0	A
I_D@T_C=100℃	Continuous Drain Current, V_{GS} @ 10V[1]	5.6	A
I_D@T_A=25℃	Continuous Drain Current, V_{GS} @ 10V[1]	1.2	A
I_D@T_A=70℃	Continuous Drain Current, V_{GS} @ 10V[1]	0.6	A
I_{DM}	Pulsed Drain Current[2]	36	A
EAS	Single Pulse Avalanche Energy[3]	220	mJ
I_{AS}	Avalanche Current	27	A
P_D@T_C=25℃	Total Power Dissipation[4]	56.0	W
P_D@T_A=25℃	Total Power Dissipation[4]	1.5	W
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient [1]	---	62	℃/W
$R_{\theta JC}$	Thermal Resistance Junction-Case[1]	---	2.1	℃/W

Electrical Characteristics (T_J=25 ℃, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=250uA	400	---	---	V
$\triangle BV_{DSS}/\triangle T_J$	BVDSS Temperature Coefficient	Reference to 25℃, ID = 250uA	---	0.3	---	V/℃
$R_{DS(ON)}$	Static Drain-Source On-Resistance[2]	VGS=10V,ID=4.5A	---	515	607	mΩ
		V_{GS}=8.0V , I_D=3A	---	1100	2000	
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D =250uA	2.0	---	4.0	V
$\triangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	-5.52	---	mV/℃
I_{DSS}	Drain-Source Leakage Current	V_{DS}=320V , V_{GS}=0V , T_J=25℃	---	---	10	uA
		V_{DS}=320V , V_{GS}=0V , T_J=55℃	---	---	100	
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V , V_{DS}=0V	---	---	±100	nA
gfs	Forward Transconductance	V_{DS}=30V , I_D=4.5A	---	8.0	---	S
R_g	Gate Resistance	V_{DS}=0V , V_{GS}=0V , f=1MHz	---	1.6	3.2	Ω
Q_g	Total Gate Charge (10V)	V_{DS}=320V , V_{GS}=10V , I_D=9A	---	25	35	nC
Q_{gs}	Gate-Source Charge		---	4.0	6.0	
Q_{gd}	Gate-Drain Charge		---	10.5	12.1	
$T_{d(on)}$	Turn-On Delay Time	V_{DD}=200V , V_{GS}=10V , R_G=5Ω I_D=9A	---	12.4	---	ns
T_r	Rise Time		---	20.1	---	
$T_{d(off)}$	Turn-Off Delay Time		---	38.5	---	
T_f	Fall Time		---	10.8	---	
C_{iss}	Input Capacitance	V_{DS}=25V , V_{GS}=0V , f=1MHz	---	740	---	pF
C_{oss}	Output Capacitance		---	83	---	
C_{rss}	Reverse Transfer Capacitance		---	9.0	---	

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
EAS	Single Pulse Avalanche Energy[5]	V_{DD}=25V , L=0.1mH , I_{AS}=10A	100	---	---	mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current[1,6]	V_G=V_D=0V , Force Current	---	---	9.0	A
I_{SM}	Pulsed Source Current[2,6]		---	---	35	A
V_{SD}	Diode Forward Voltage[2]	V_{GS}=0V , I_S=4.5A	---	---	1.5	V
t_{rr}	Reverse Recovery Time	IF=9A , dI/dt=100A/μs	---	320	---	nS
Q_{rr}	Reverse Recovery Charge		---	1345	---	nC

Note :
1.The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper,t<10sec.
2.The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%
3.The EAS data shows Max. rating . The test condition is V_{DD}=25V,V_{GS}=10V,L=0.1mH,I_{AS}=10A
4.The power dissipation is limited by 150℃ junction temperature
5.The Min. value is 100% EAS tested guarantee.
6.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Performance Characteristics

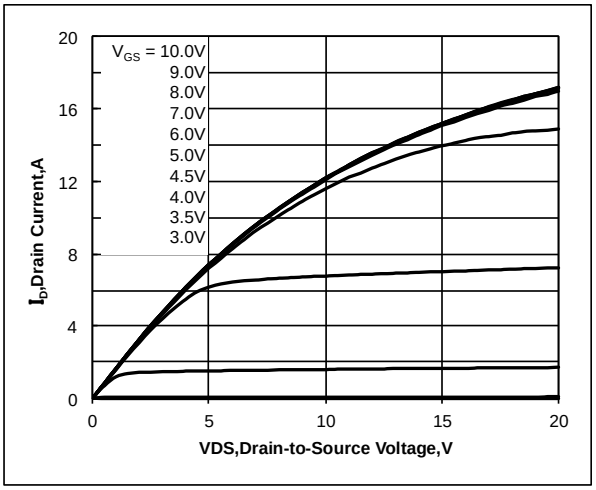


Figure 1. Output Characteristics

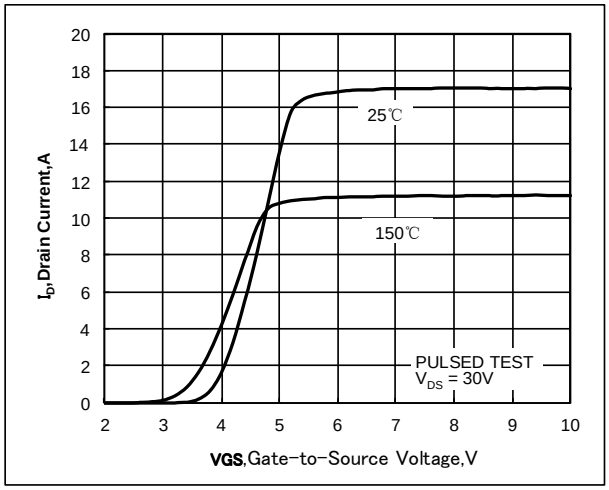


Figure 2. Transfer Characteristics

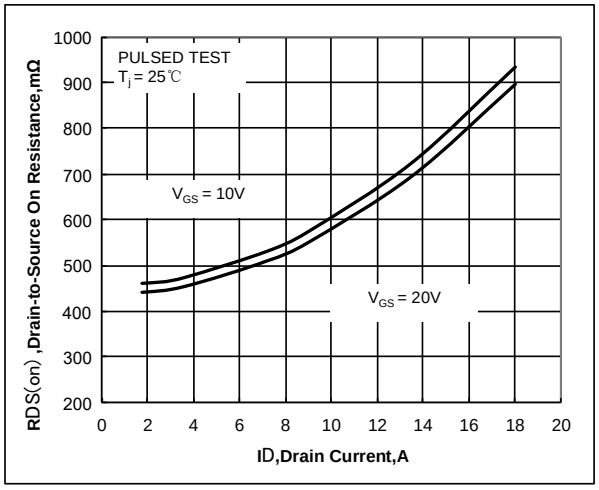


Figure 3. Drain-to-Source On Resistance vs. Drain Current and Gate Voltage

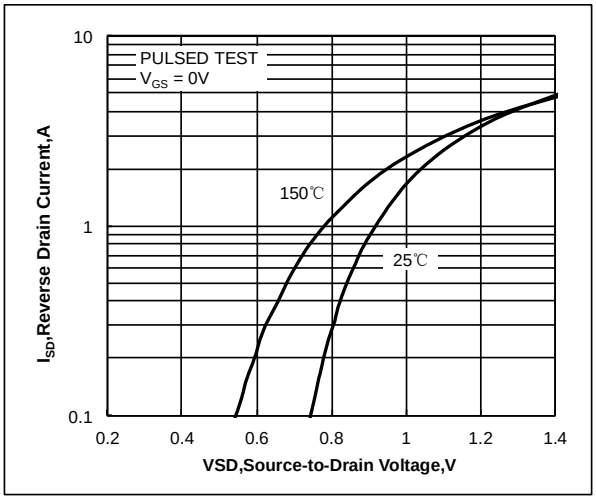


Figure 4. Body Diode Forward Voltage vs. Source Current and Temperature

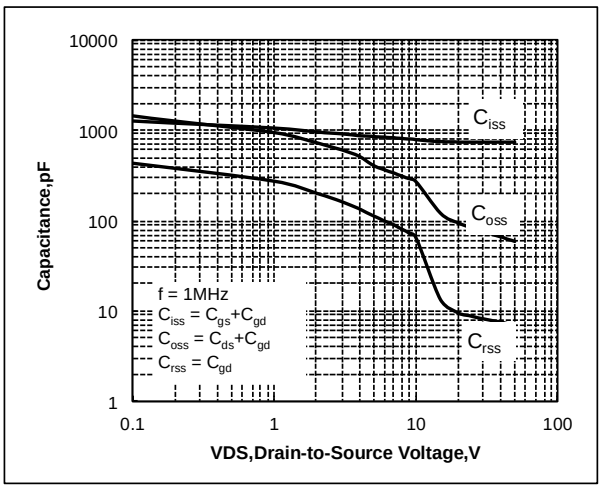


Figure 5. Capacitance Characteristics

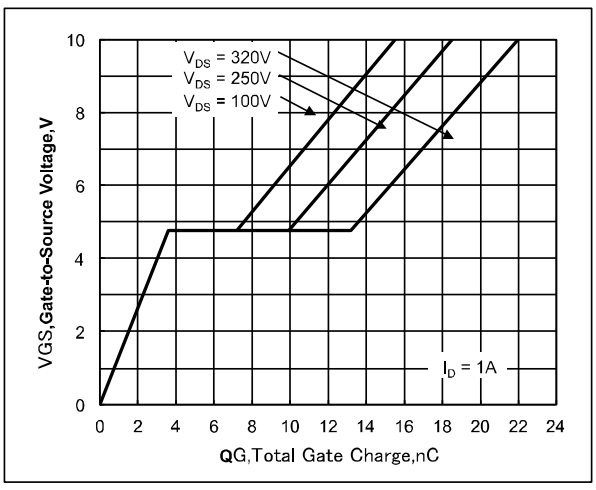


Figure 6. Gate Charge Characteristics

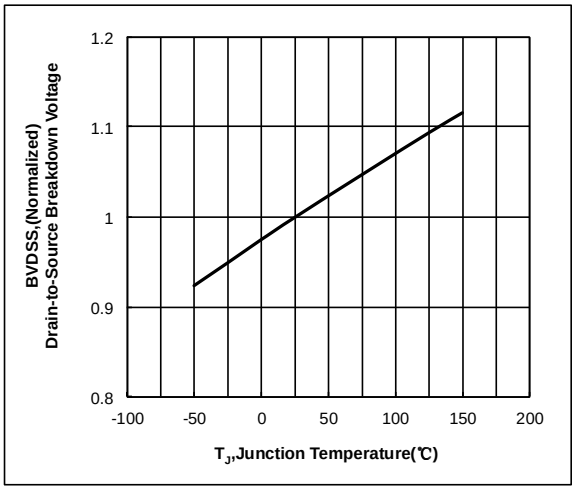


Figure 7. Normalized Breakdown Voltage vs. Junction Temperature

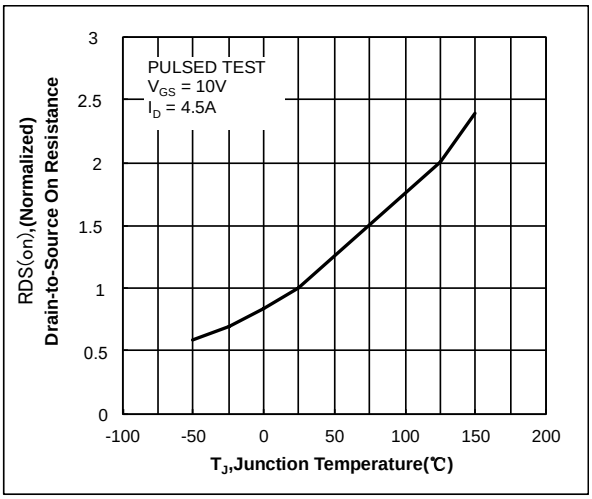


Figure 8. Normalized On Resistance vs. Junction Temperature

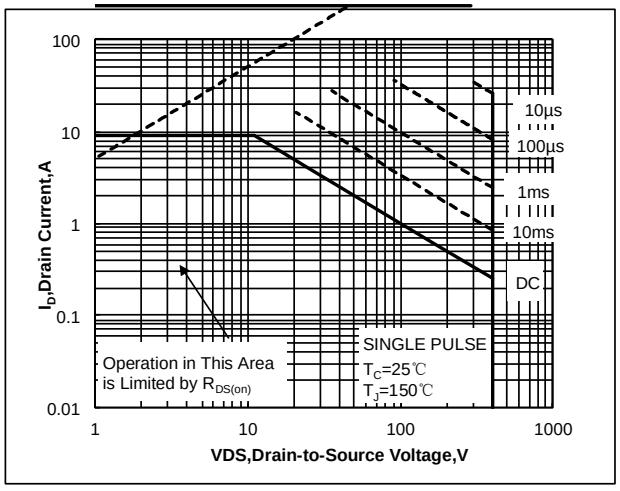


Figure 9. Maximum Safe Operating Area

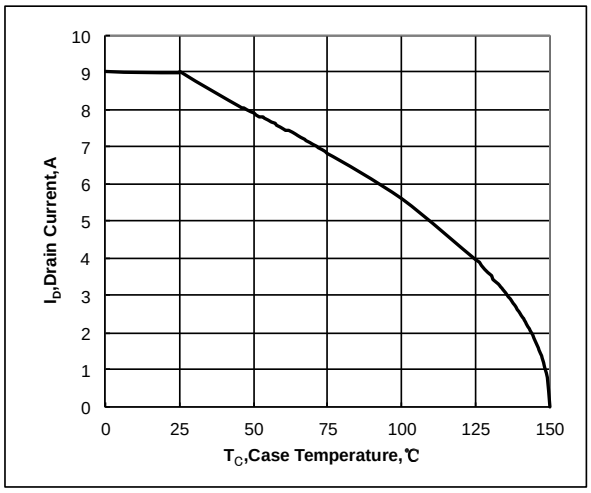


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

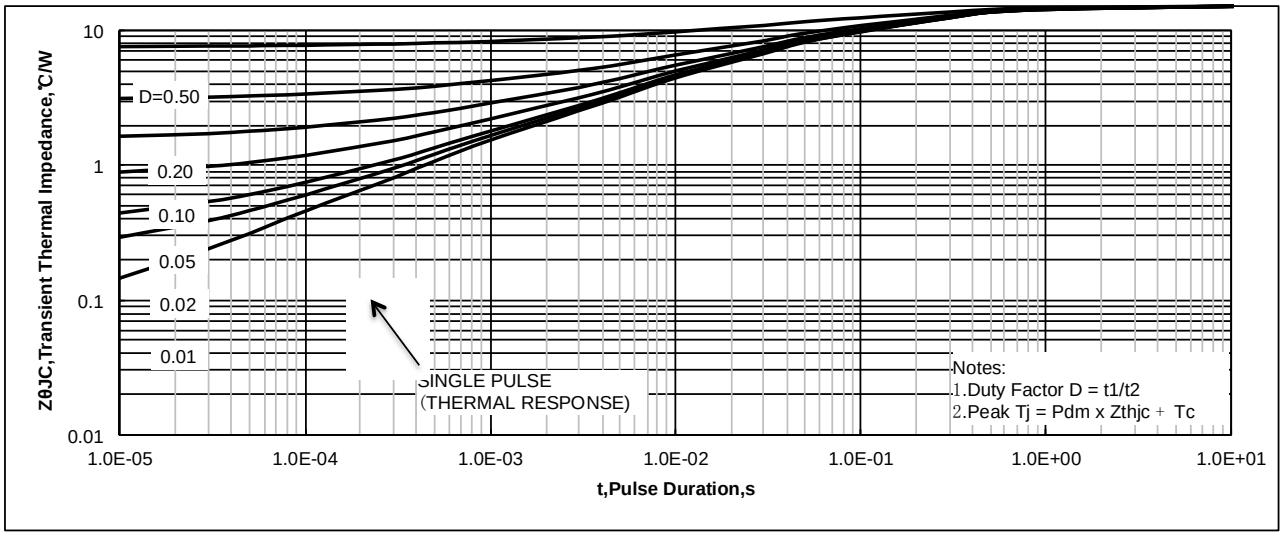
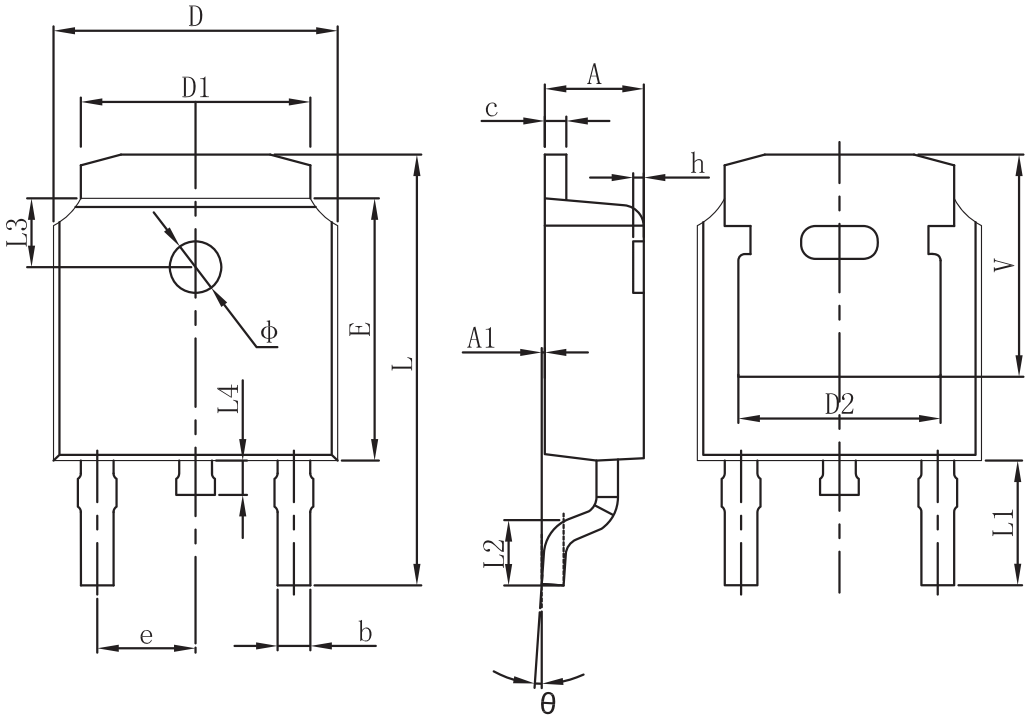


Figure 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

Packaging information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	

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